1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 1 A
- Reverse voltage: V_R ≤ 60 V
- · Extremely low leakage current
- · Low forward voltage
- High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- High temperature T_i ≤ 175 °C
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IF	forward current	T _{sp} = 165 °C		-	-	1.4	Α
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{amb} ≤ 140 °C	[1]	-	-	1	А
		δ = 0.5; f = 20 kHz; square wave; T _{sp} \leq 170 °C		-	-	1	А
V _R	reverse voltage	T _j = 25 °C		-	-	60	V
V _F	forward voltage	I _F = 1 A; T _j = 25 °C		-	460	530	mV
I _R	reverse current	$V_R = 60 \text{ V}; t_p \le 300 \text{ µs}; \delta \le 0.02;$ $T_j = 25 \text{ °C}; \text{ pulsed}$		-	30	60	μΑ
t _{rr}	reverse recovery time	$I_F = 0.5 \text{ A}$; $I_R = 0.5 \text{ A}$; $I_{R(meas)} = 0.1 \text{ A}$; $T_j = 25 \text{ °C}$		-	4.4	-	ns

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	1 2	К _[< -A
2	А	anode	CFP3 (SOD123W)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG6010ETR-Q	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG6010ETR-Q	EK

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	60	V
IF	forward current	T _{sp} = 165 °C		-	1.4	A
I _{F(AV)}	average forward current	δ = 0.5; f = 20 kHz; square wave; T _{amb} ≤ 140 °C	[1]	-	1	А
		δ = 0.5; f = 20 kHz; square wave; T _{sp} ≤ 170 °C		-	1	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; half-sine wave; $T_{j(init)}$ = 25 °C		-	50	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	680	mW
			[3]	-	1.15	W
			[1]	-	2.14	W
T _j	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

^[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

^[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from		[1] [2]	-	-	220	K/W
	junction to ambient		[1] [3]	-	-	130	K/W
			[1] [4]	-	-	70	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		[5]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

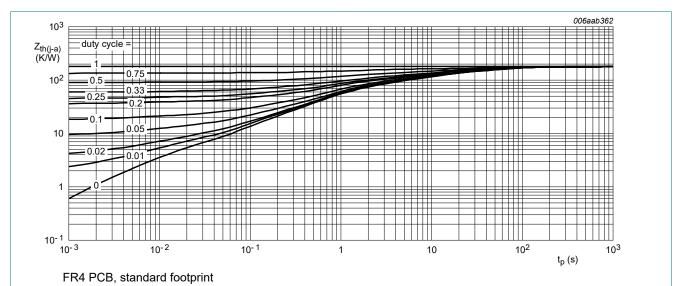


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

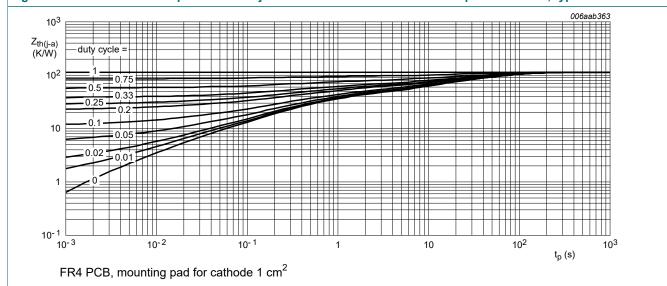
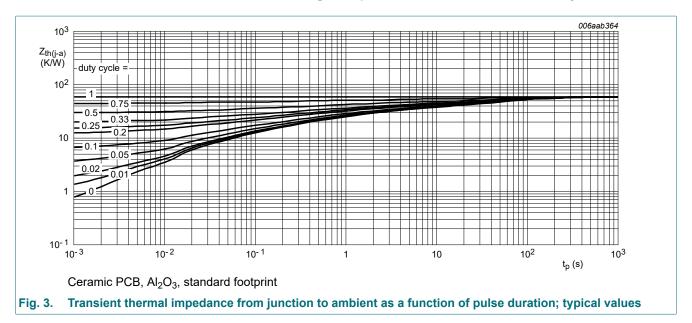


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _F	forward voltage	I _F = 0.1 A; T _j = 25 °C	-	320	370	mV
		I _F = 0.7 A; T _j = 25 °C	-	430	490	mV
		I _F = 1 A; T _j = 25 °C	-	460	530	mV
		I _F = 1 A; T _j = -40 °C	-	510	590	mV
		I _F = 1 A; T _j = 125 °C	-	400	480	mV
		I _F = 1 A; T _j = 150 °C	-	380	460	mV
		I _F = 1 A; T _j = 175 °C	-	365	450	mV
I _R	reverse current	$V_R = 5 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	1.2	-	μA
		V_R = 10 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 25 °C; pulsed	-	1.7	-	μΑ
		V_R = 60 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 25 °C; pulsed	-	30	60	μA
		V_R = 60 V; t_p ≤ 300 μs; δ ≤ 0.02; T_j = -40 °C; pulsed	-	0.6	10	μΑ
		V_R = 60 V; $t_p \le 300 \mu s$; δ ≤ 0.02; T_j = 125 °C; pulsed	-	14	50	mA
C _d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	120	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	40	-	pF
rr	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 \text{ °C}$	-	4.4	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 40 \text{ A}/\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	500	-	mV

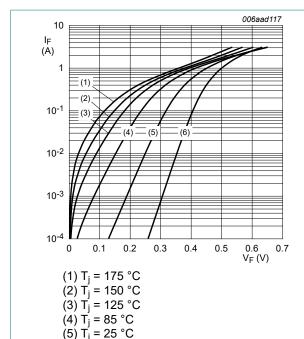


Fig. 4. Forward current as a function of forward voltage; typical values

(6) $T_i = -40 \, ^{\circ}\text{C}$

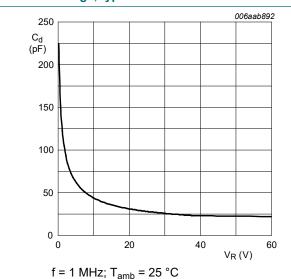
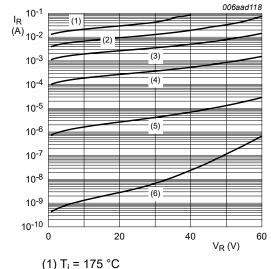


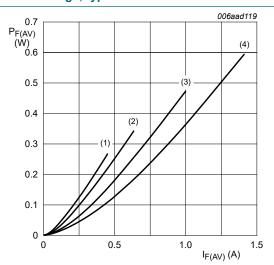
Fig. 6. Diode capacitance as a function of reverse voltage; typical values



(1) $T_j = 175 \,^{\circ}\text{C}$ (2) $T_j = 150 \,^{\circ}\text{C}$ (3) $T_j = 125 \,^{\circ}\text{C}$ (4) $T_j = 85 \,^{\circ}\text{C}$ (5) $T_j = 25 \,^{\circ}\text{C}$

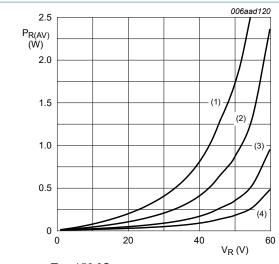
(6) $T_i = -40 \,^{\circ}\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



 $T_j = 175 \,^{\circ}\text{C}$ (1) $\delta = 0.1$ (2) $\delta = 0.2$ (3) $\delta = 0.5$ (4) $\delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



 $T_j = 150 \,^{\circ}C$

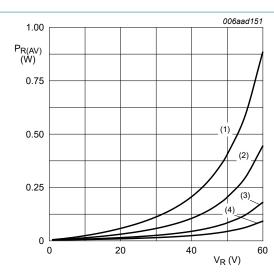
 $(1) \delta = 1$

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$

 $(4) \delta = 0.1$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



 $T_j = 125 \, ^{\circ}C$

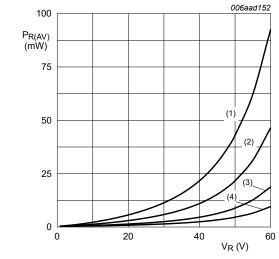
 $(1) \delta = 1$

 $(2) \delta = 0.5$

(3) $\delta = 0.2$

 $(4) \delta = 0.1$

Fig. 9. Average reverse power dissipation as a function of reverse voltage; typical values



 $T_j = 85 \,^{\circ}C$

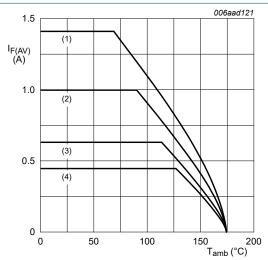
 $(1) \delta = 1$

 $(2) \delta = 0.5$

 $(3) \delta = 0.2$

 $(4) \delta = 0.1$

Fig. 10. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

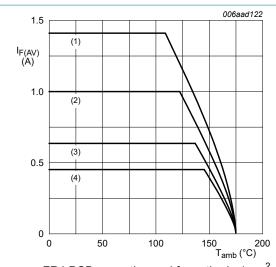
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm^2

 $T_i = 175 \,{}^{\circ}\text{C}$

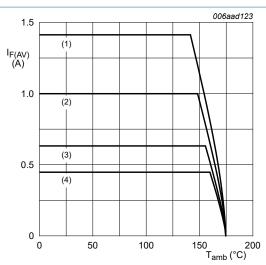
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 12. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

T_i = 175 °C

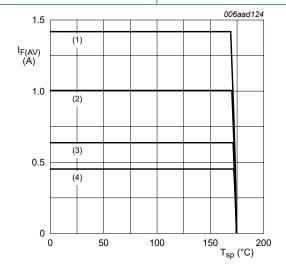
 $(1) \delta = 1 (DC)$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 13. Average forward current as a function of ambient temperature; typical values



T_i = 175 °C

 $(1) \delta = 1 (DC)$

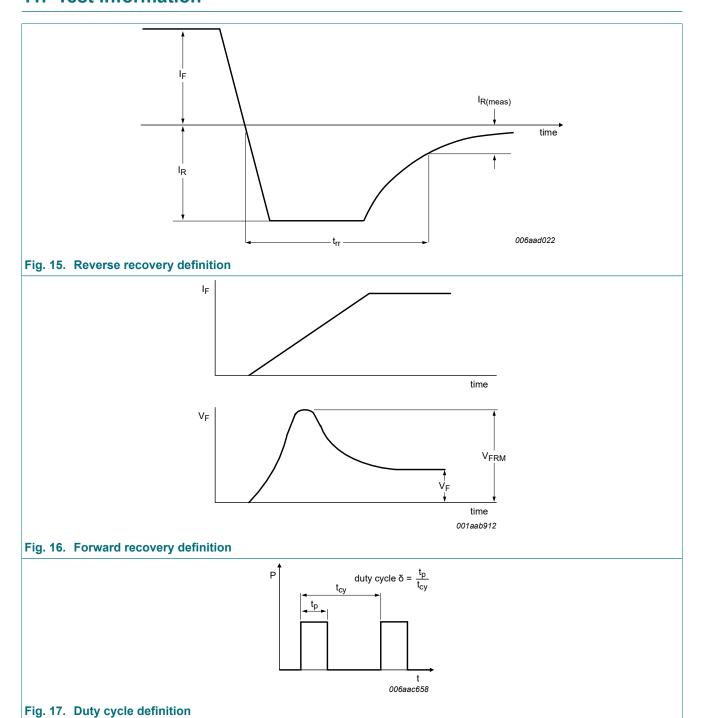
(2) $\delta = 0.5$; f = 20 kHz

 $(3) \delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 14. Average forward current as a function of solder point temperature; typical values

11. Test information



The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current,

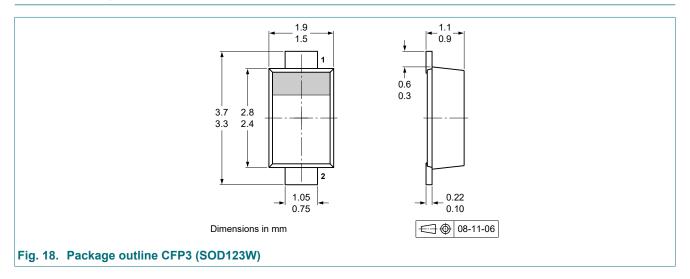
 $I_{RMS} = I_{F(AV)}$ at DC,

 $I_{RMS} = I_{M} \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

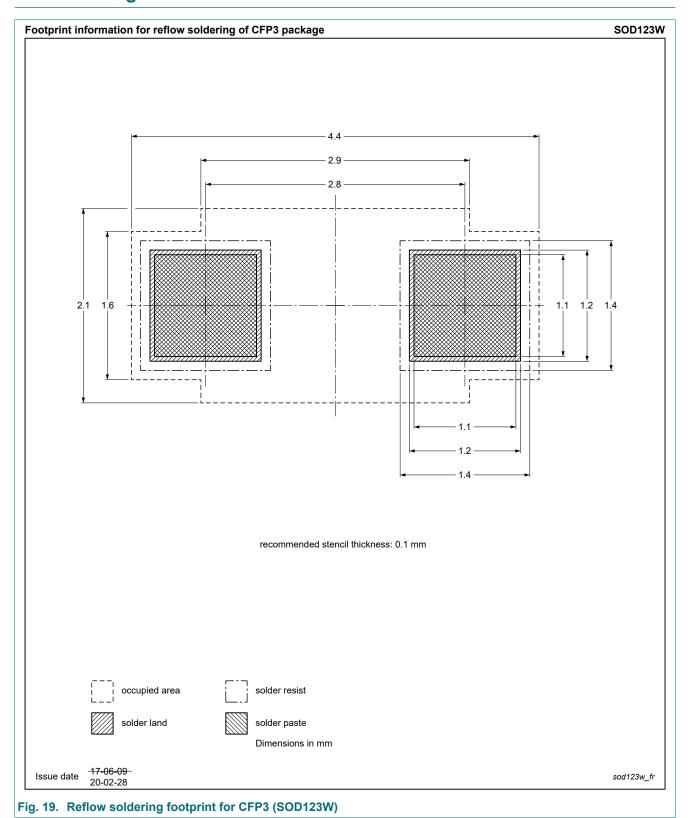
Quality information

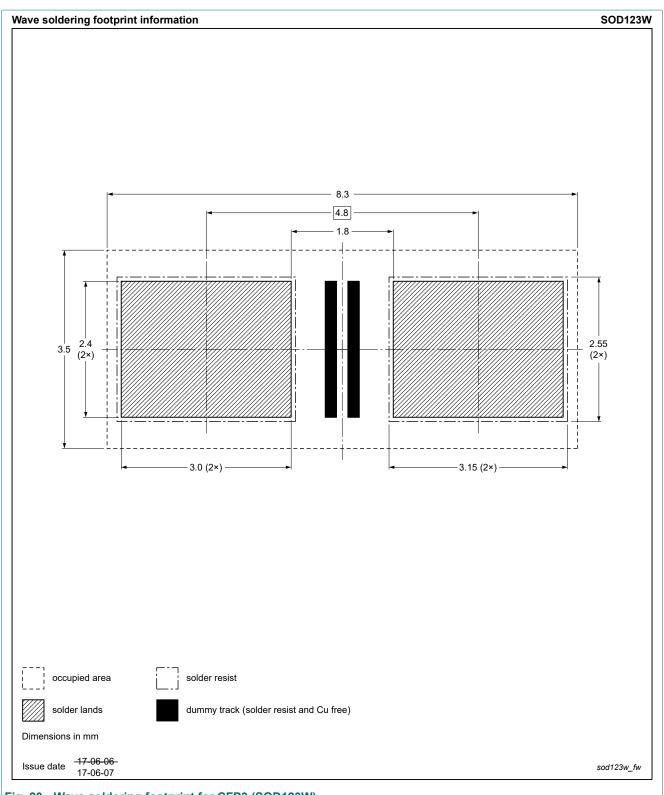
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

- Laboration in the contract of the contract o								
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG6010ETR-Q v.2	20221222	Product data sheet	-	PMEG6010ETR-Q v.1				
Modifications:	Limiting values: Mea wave.	 Limiting values: Measurement conditions for I_{FSM} changed from square wave to half-sine wave. 						
PMEG6010ETR-Q v.1	20210719	Product data sheet	-	-				

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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For more information, please visit: http://www.nexperia.com
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